# **Hyperfast Diode**

30 A, 400 V - 600 V

# RHRG3040, RHRG3060

#### Description

The RHRG3040, RHRG3060 is a hyperfast diode with soft recovery characteristics. It has the half recovery time of ultrafast diodes and is silicon nitride passivated ionimplanted epitaxial planar construction. These devices are intended to be used as freewheeling/clamping diodes and diodes in a variety of switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

#### Features

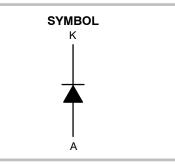
- Hyperfast Recovery  $t_{rr} = 45 \text{ ns} (@ I_F = 30 \text{ A})$
- Max Forward Voltage,  $V_F = 2.1 \text{ V} (@ T_C = 25^{\circ}\text{C})$
- 400 V, 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- These Devices are Pb-Free and are RoHS Compliant

#### Applications

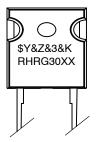
- Switching Power Supplies
- Power Switching Circuits
- General Purpose







#### MARKING DIAGRAM



\$Y	= ON Semiconductor Logo
&Z	= Assembly Plant Code
&3	= Numeric Date Code
&K	= Lot Code
RHRG30XX	= Specific Device Code
XX	= 40, 60

#### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

## **RHRG3040, RHRG3060**

#### **ABSOLUTE MAXIMUM RATINGS** ( $T_C = 25^{\circ}C$ , unless otherwise specified)

Parameter	Symbol	RHRG3040	RHRG3060	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	400	600	V
Working Peak Reverse Voltage	V <sub>RWM</sub>	400	600	V
DC Blocking Voltage	V <sub>R</sub>	400	600	V
Average Rectified Forward Current ( $T_C = 120^{\circ}C$ )	I <sub>F(AV)</sub>	30	30	А
Repetitive Peak Surge Current (Square Wave, 20 kHz)	I <sub>FRM</sub>	70	70	А
Non-repetitive Peak Surge Current (Halfwave, 1 Phase, 60 Hz)	I <sub>FSM</sub>	325	325	А
Maximum Power Dissipation	PD	125	125	W
Avalanche Energy (See Figures 10 and 11)	E <sub>AVL</sub>	20	20	mJ
Operating and Storage Temperature	T <sub>STG</sub> , T <sub>J</sub>	-65 to 175	-65 to 175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package	Shipping		
RHRG3040	RHRG3040	TO-247-2LD	450 / Tube		
RHRG3060	RHRG3060	TO-247-2LD	450 / Tube		

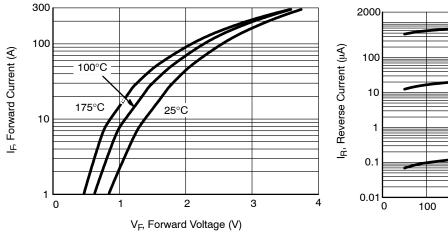
#### **ELECTRICAL SPECIFICATION** ( $T_C = 25^{\circ}C$ , unless otherwise specified)

			RHRG3040			RHRG3060			
Characteristics	Symbol	Test Condition	Min	Тур	Max	Min	Тур	Max	Unit
Instantaneous Forward Voltage (Pulse Width = 300 μs, Duty Cycle = 2%)	V <sub>F</sub>	I <sub>F</sub> = 30 A	-	-	2.1	-	-	2.1	V
		I <sub>F</sub> = 30 A, T <sub>C</sub> = 150°C	-	-	1.7	-	-	1.7	V
Instantaneous Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 400 V	-	-	250	-	-	-	μA
		V <sub>R</sub> = 600 V	-	-	-	-	-	250	μA
		$V_{R}$ = 400 V, $T_{C}$ = 150°C	-	-	1.0	-	-	-	mA
		$V_{R}$ = 600 V, $T_{C}$ = 150°C	-	-	-	-	-	1.0	mA
Reverse Recovery Time	, , , , , , , , , , , , , , , , , , , ,	$I_F = 1 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}$	-	-	40	-	-	40	ns
(See Figure 9) Summation of t <sub>a</sub> + t <sub>b</sub>		$I_F$ = 30 A, dI <sub>F</sub> /dt = 200 A/µs	-	-	45	-	-	45	ns
Time to Reach Peak Reverse Current (See Figure 9)	t <sub>a</sub>	$I_F$ = 30 A, dI <sub>F</sub> /dt = 200 A/µs	-	22	-	-	22	-	ns
Time from Peak $I_{RM}$ to Projected Zero Crossing of $I_{RM}$ Based on a Straight Line from Peak $I_{RM}$ through 25% of $I_{RM}$ (See Figure 9)	t <sub>b</sub>	I <sub>F</sub> = 30 A, dI <sub>F</sub> /dt = 200 A/μs	-	18	-	_	18	_	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$I_F = 30 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}$	-	100		-	100	-	nC
Junction Capacitance	CJ	V <sub>R</sub> = 10 V, I <sub>F</sub> = 0 A	-	85		-	85	-	pF
Thermal Resistance Junction to Case	$R_{\theta JC}$		-	_	1.2	_	-	1.2	°C/W

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## RHRG3040, RHRG3060

### **TYPICAL PERFORMANCE CURVES**





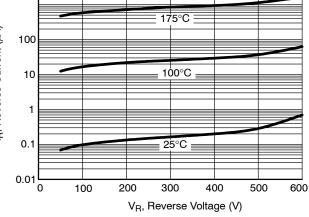


Figure 2. Reverse Current vs. Reverse Voltage

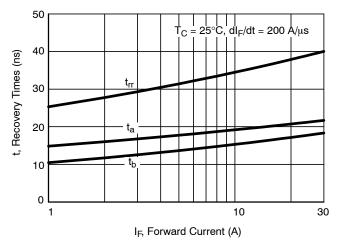


Figure 3.  $t_{rr},\,t_a$  and  $t_b$  Curves vs. Forward Current

175°C.

 $T_{C}$  =

tb

150

125

100

75

50

25

0

1

t, Recovery Times (ns)

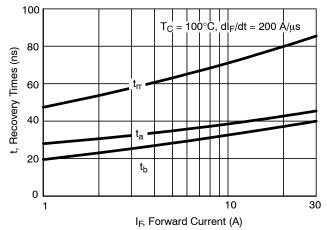


Figure 4. t<sub>rr</sub>, t<sub>a</sub> and t<sub>b</sub> Curves vs. Forward Current

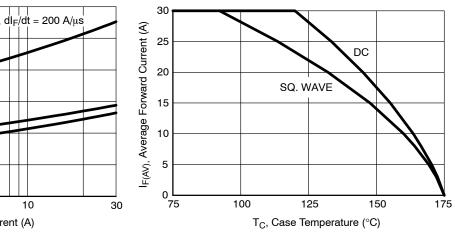


Figure 5. t<sub>rr</sub>, t<sub>a</sub> and t<sub>b</sub> Curves vs. Forward Current

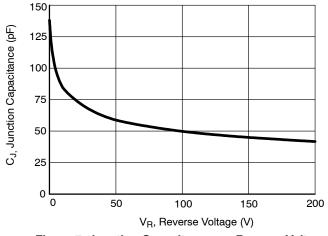
I<sub>F</sub>, Forward Current (A)

10



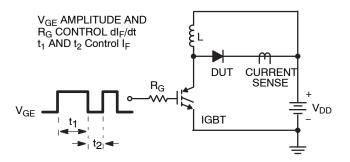
## **RHRG3040, RHRG3060**

#### TYPICAL PERFORMANCE CURVES (continued)





#### **TEST CIRCUITS AND WAVEFORMS**





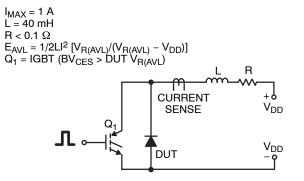


Figure 10. Avalanche Energy Test Circuit

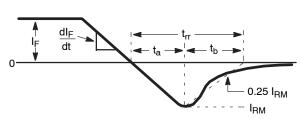


Figure 9. t<sub>rr</sub> Waveforms and Definitions

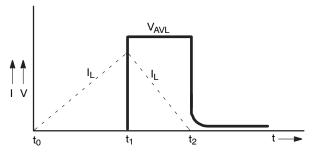


Figure 11. Avalanche Current and Voltage Waveforms

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**MILLIMETERS** 

NOM

4.70

2.40

1.50

1.26

1.65

0.61

20.57

16.57

0.93

15.62

~

5.08

11.12

16.00

3.81

3.58

6.73

5.46

5.46

MAX

4.82

2.66

1.70

1.35

1.77

0.71

20.82

16.77

1.35

15.87

~

5.20

~

16.25

3.93

3.65

6.85

5.58

5.58

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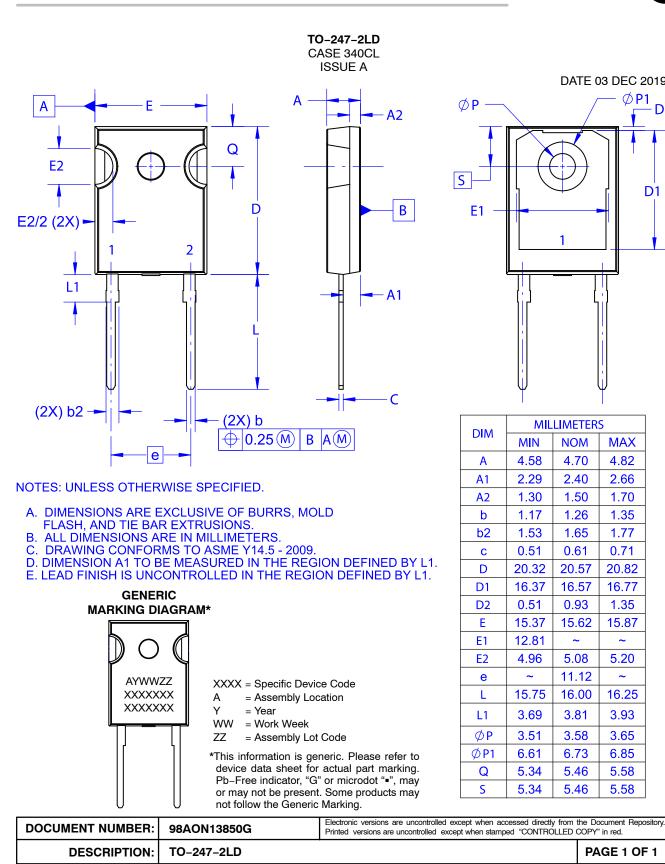
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